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# **Phase Control Thyristor**

DS5804-4 January 2014 (LN31244)

## **FEATURES**

- Double Side Cooling
- High Surge Capability

## **KEY PARAMETERS**

5200V
2720A
36700A
1500V/µs
300A/µs

## **APPLICATIONS**

- High Power Drives
- High Voltage Power Supplies
- Static Switches

## **VOLTAGE RATINGS**

Part and Ordering Number	Repetitive Peak Voltages V <sub>DRM</sub> and V <sub>RRM</sub> V	Conditions
DCR2720V52* DCR2720V50 DCR2720V48	5200 5000 4800	$\begin{array}{l} T_{vj} = -40^{\circ}C \ to \ 125^{\circ}C, \\ I_{DRM} = I_{RRM} = 200mA, \\ V_{DRM}, \ V_{RRM} \ t_p = 10ms, \\ V_{DSM} \& \ V_{RSM} = \\ V_{DRM} \& \ V_{RRM} + 100V \\ respectively \end{array}$

Lower voltage grades available. \* 5000V @  $-40^{\circ}$  C, 5200V @  $0^{\circ}$  C

## **ORDERING INFORMATION**

When ordering, select the required part number shown in the Voltage Ratings selection table.

For example:

## DCR2720V52

Note: Please use the complete part number when ordering and quote this number in any future correspondence relating to your order.



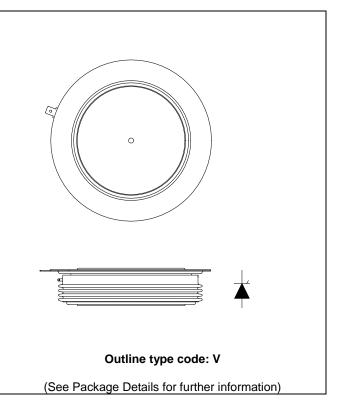


Fig. 1 Package outline





# **CURRENT RATINGS**

 $T_{case} = 60^{\circ}C$  unless stated otherwise

Symbol	Parameter	Test Conditions		Units		
Double Sid	Double Side Cooled					
I <sub>T(AV)</sub>	Mean on-state current	Half wave resistive load	2720	А		
I <sub>T(RMS)</sub>	RMS value	-	4270	А		
Ι <sub>Τ</sub>	Continuous (direct) on-state current	-	4120	А		

## SURGE RATINGS

Symbol	Parameter	Test Conditions	Max.	Units
I <sub>TSM</sub>	Surge (non-repetitive) on-state current	10ms half sine, $T_{case} = 125^{\circ}C$	36.7	kA
l <sup>2</sup> t	I <sup>2</sup> t for fusing	$V_R = 0$	6.73	MA <sup>2</sup> s

## THERMAL AND MECHANICAL RATINGS

Symbol	Parameter	Test Conditions		Min.	Max.	Units
R <sub>th(j-c)</sub>	Thermal resistance – junction to case	Double side cooled	DC	-	0.00746	°C/W
		Single side cooled	Anode DC	-	0.0130	°C/W
			Cathode DC	-	0.0178	°C/W
R <sub>th(c-h)</sub>	Thermal resistance – case to heatsink	Clamping force 54kN	Double side	-	0.002	°C/W
		(with mounting compound)	Single side	-	0.004	°C/W
$T_{vj}$	Virtual junction temperature	Blocking V <sub>DRM</sub> / <sub>VRRM</sub>		-	125	°C
T <sub>stg</sub>	Storage temperature range			-55	125	°C
Fm	Clamping force			48.0	59.0	kN





# **DYNAMIC CHARACTERISTICS**

Symbol	Parameter	Test Conditions		Min.	Max.	Units
I <sub>RRM</sub> /I <sub>DRM</sub>	Peak reverse and off-state current	At V <sub>RRM</sub> /V <sub>DRM</sub> , T <sub>case</sub> = 125°C		-	200	mA
dV/dt	Max. linear rate of rise of off-state voltage	To 67% V <sub>DRM</sub> , T <sub>j</sub> = 125°C, ga	ate open	-	1500	V/µs
dl/dt	Rate of rise of on-state current	From 67% $V_{\text{DRM}}$ to 2x $I_{\text{T(AV)}}$	Repetitive 50Hz	-	150	A/µs
		Gate source 30V, 10Ω, t <sub>r</sub> < 0.5μs, T <sub>i</sub> = 125°C	Non-repetitive	-	300	A/µs
V <sub>T(TO)</sub>	Threshold voltage – Low level	500A to 2000A at T <sub>case</sub> = 125	5°C	-	0.90	V
	Threshold voltage – High level	2000A to 7200A at T <sub>case</sub> = 125°C		-	1.1	V
r <sub>T</sub>	On-state slope resistance – Low level	500A to 2000A at T <sub>case</sub> = 125°C		-	0.3428	mΩ
	On-state slope resistance – High level	2000A to 7200A at T <sub>case</sub> = 125°C		-	0.2414	mΩ
t <sub>gd</sub>	Delay time	$V_D = 67\% V_{DRM}$ , gate source 30V, 10 $\Omega$ $t_r = 0.5 \mu$ s, $T_j = 25^{\circ}$ C		-	3	μs
t <sub>q</sub>	Turn-off time	$T_{j} = 125^{\circ}C, V_{R} = 200V, dI/dt = 1A/\mu s,$ $dV_{DR}/dt = 20V/\mu s \text{ linear}$		-	600	μs
Qs	Stored charge	$I_T = 2000A, T_j = 125^{\circ}C, dI/dt - 1A/\mu s,$		2000	4750	μC
ΙL	Latching current	$T_j = 25^{\circ}C, V_D = 5V$		-	3	А
I <sub>Η</sub>	Holding current	$T_j = 25^{\circ}C, R_{G-K} = \infty, I_{TM} = 500A, I_T = 5A$		-	300	mA

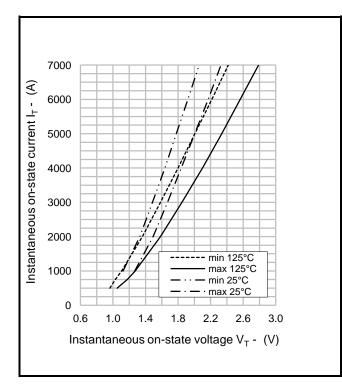




# GATE TRIGGER CHARACTERISTICS AND RATINGS

Symbol	Parameter	Test Conditions	Max.	Units
V <sub>GT</sub>	Gate trigger voltage	$V_{DRM} = 5V, T_{case} = 25^{\circ}C$	1.5	V
$V_{GD}$	Gate non-trigger voltage	At 50% V <sub>DRM,</sub> T <sub>case</sub> = 125°C	0.4	V
I <sub>GT</sub>	Gate trigger current	$V_{DRM} = 5V, T_{case} = 25^{\circ}C$	350	mA
I <sub>GD</sub>	Gate non-trigger current	At 50% V <sub>DRM</sub> , T <sub>case</sub> = 125°C	15	mA

## CURVES



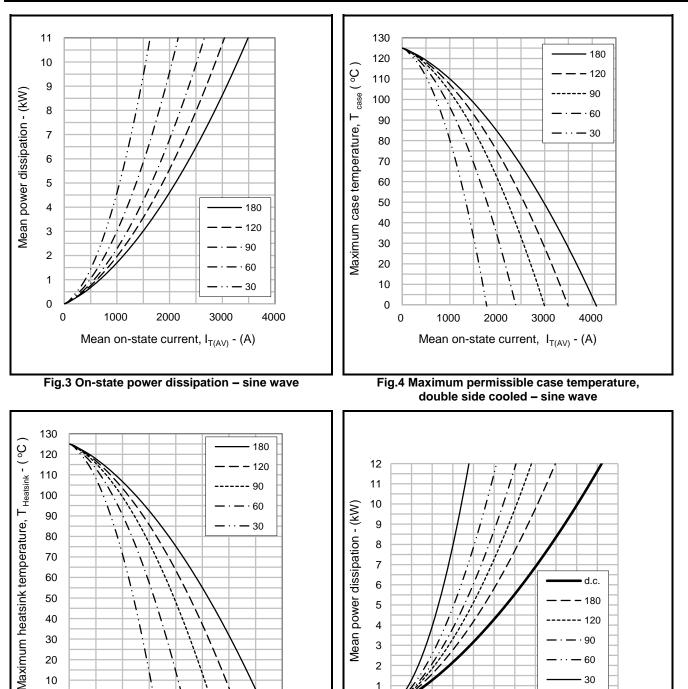
## Fig.2 Maximum & minimum on-state characteristics

V<sub>TM</sub> EQUATION

 $V_{TM} = A + BIn (I_T) + C.I_T + D.\sqrt{I_T}$ 

Where A = -0.450546 B = 0.251217 C = 0.000242 D = -0.008134these values are valid for T<sub>i</sub> = 125°C for I<sub>T</sub> 500A to 7200A





Mean on-state current, I<sub>T(AV)</sub> - (A)

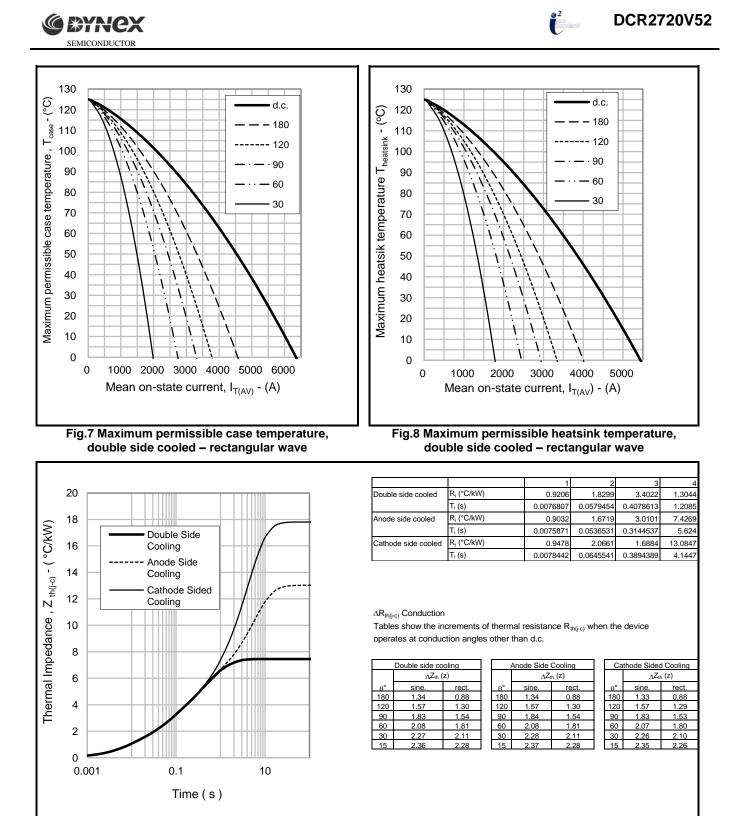
Fig.6 On-state power dissipation - rectangular wave

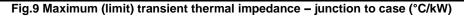
Mean on-state current, I<sub>T(AV)</sub> - (A)

Fig.5 Maximum permissible heatsink temperature,

double side cooled - sine wave

DCR2720V52





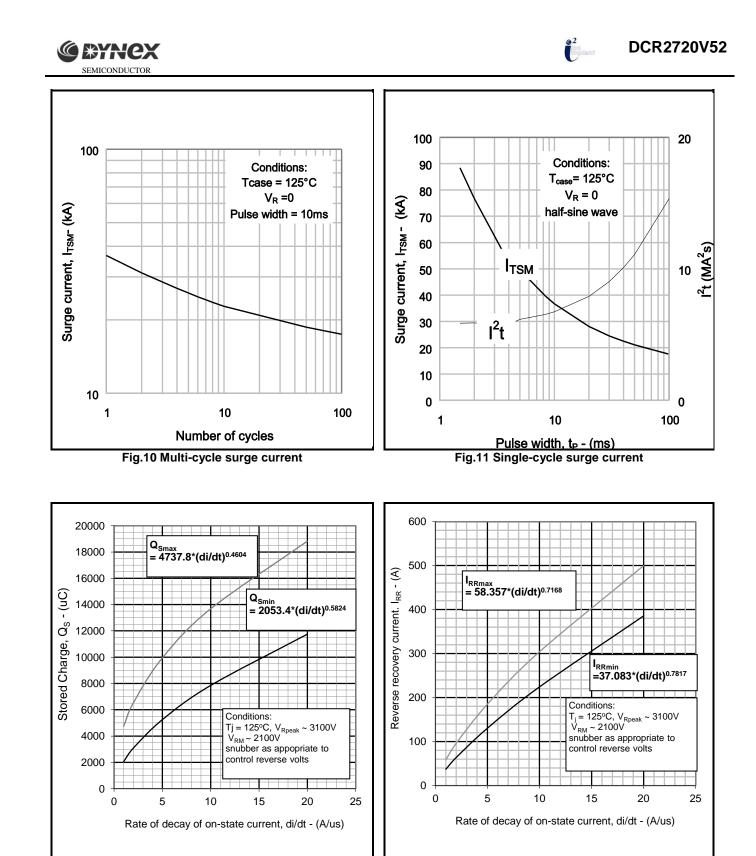
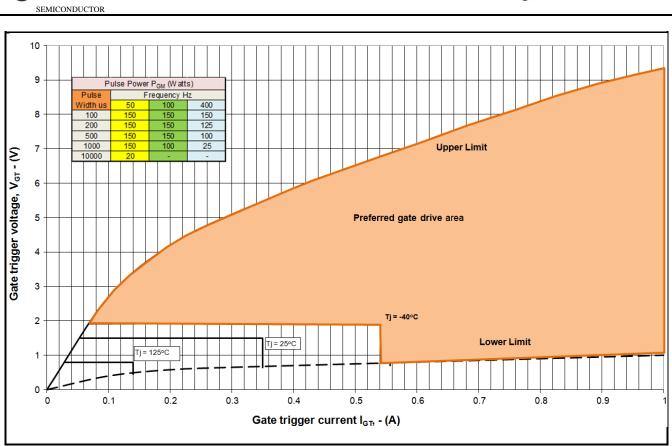


Fig.12 Stored charge

Fig.13 Reverse recovery current



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DCR2720V52

**Fig14 Gate Characteristics** 

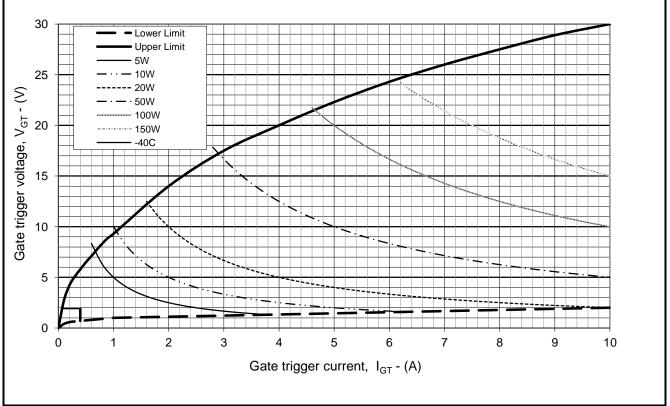


Fig. 15 Gate characteristics

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## PACKAGE DETAILS

For further package information, please contact Customer Services. All dimensions in mm, unless stated otherwise. DO NOT SCALE.

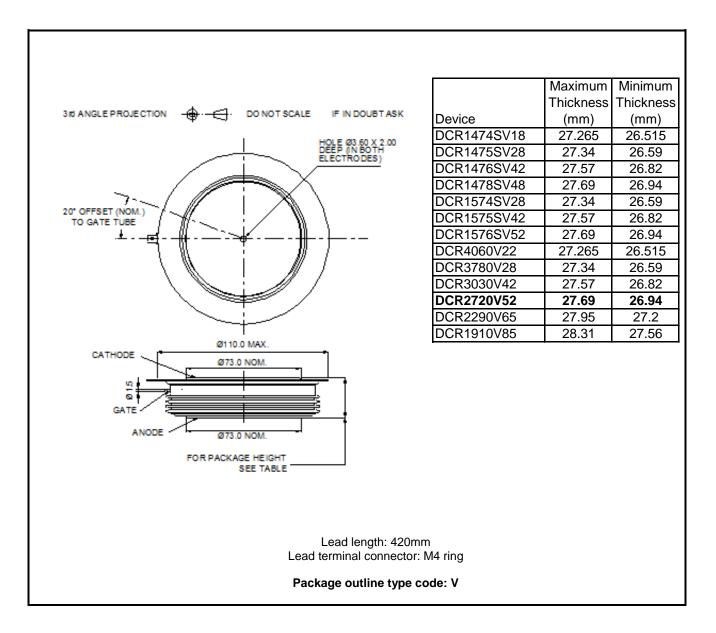


Fig.16 Package outline





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